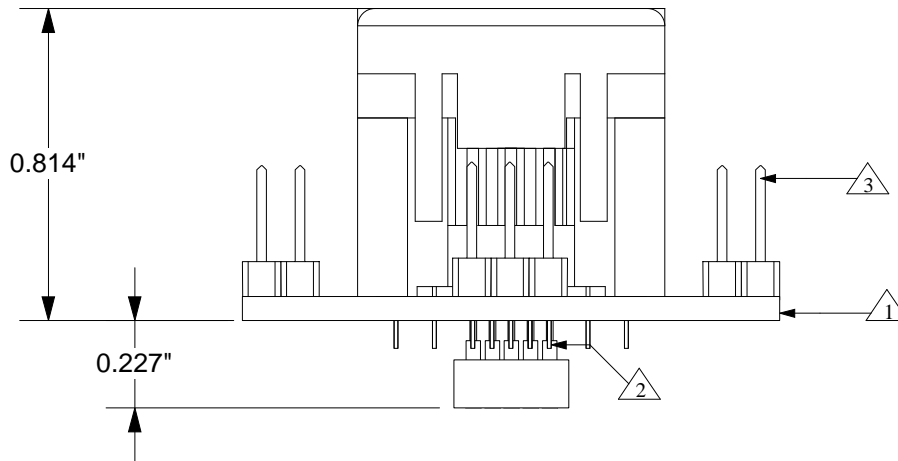


Top View



Side View


- △ 1 Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating
- △ 2 Pins: shell material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Nil (min.). Contact material- BeCu; finish 10µ" Au over 100µ" Ni (min.)
- △ 3 Test points: material- Phosphor Bronze; plating- Sn over 50µ" Ni. Gold flash on contact end.

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Description: Carrier Adapter

20 Position PLCC ZIF Socket with test points to mini-grid array interface. Pin mapping is 1:1.

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.

| | | | | |
|---|------------------------------|------------------|----------------------------------|--------|
| CA-PLCC20-Z-M-T-01 Drawing | | Status: Released | Scale 2:1 | Rev: A |
|  <p>© 1998 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com</p> | Drawing: M. Gilk | | Date: 6/09/98 | |
| | File: CA-PLCC20-Z-M-T-01 Dwg | | Modified: www.DataSheet4U.com | |